

HIGH TOUGHNESS

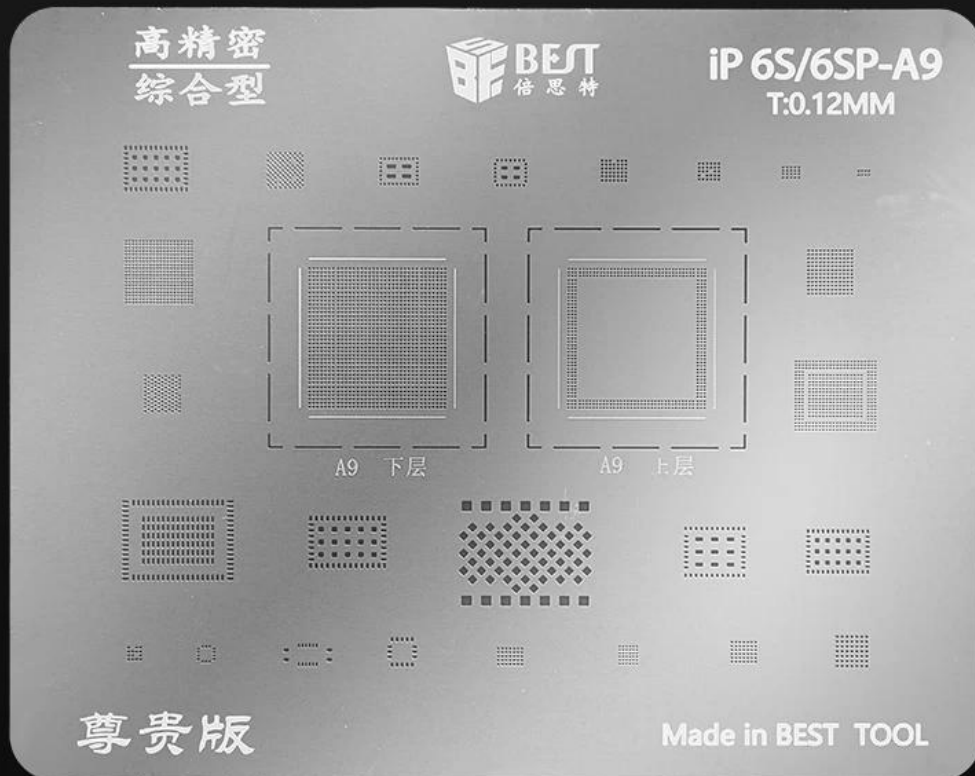
BGA IC

Soldering Reballing Stencil



iP 6S/6SP-A9

Strong magnetic steel



Product Usage

Model NO.	iP 6S/6SP-A9
Name	Reballing Stencil
Material	Strong magnetic steel
Melting point	700°C
G.W.	12.9g
Size	3.36*4.30 in.



Strong magnetic steel

Effectively reduce swelling

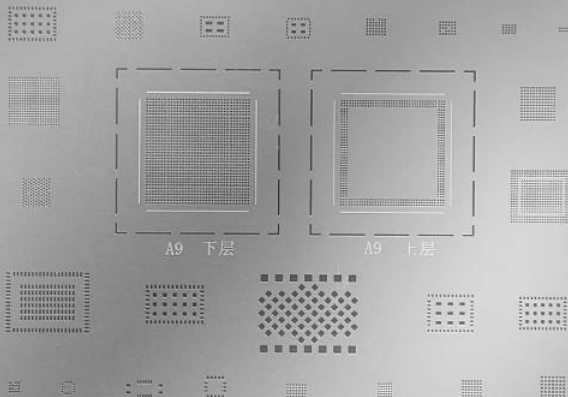
700°C



高精度
综合型



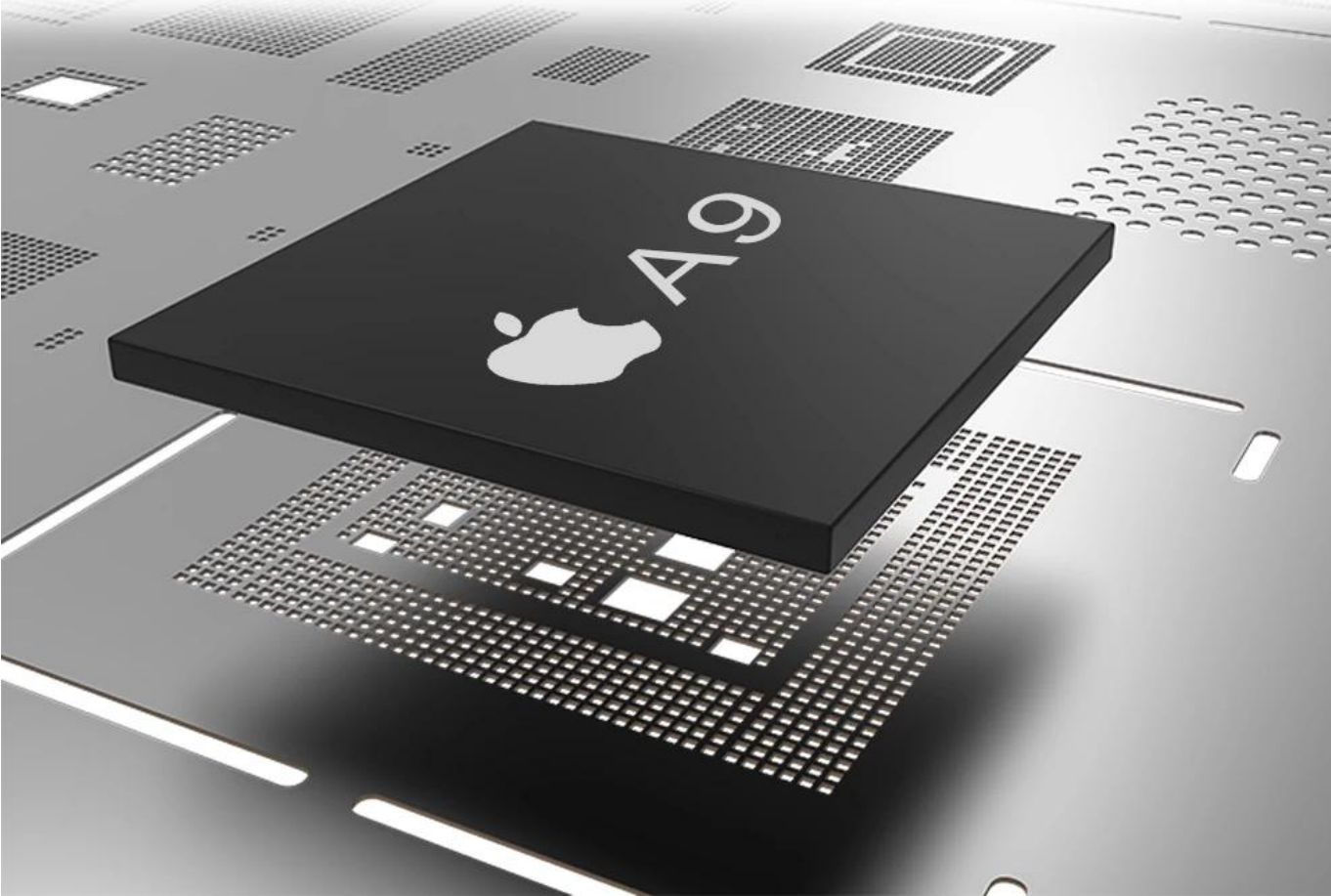
IP 6S/6SP-A9
T:0.12MM



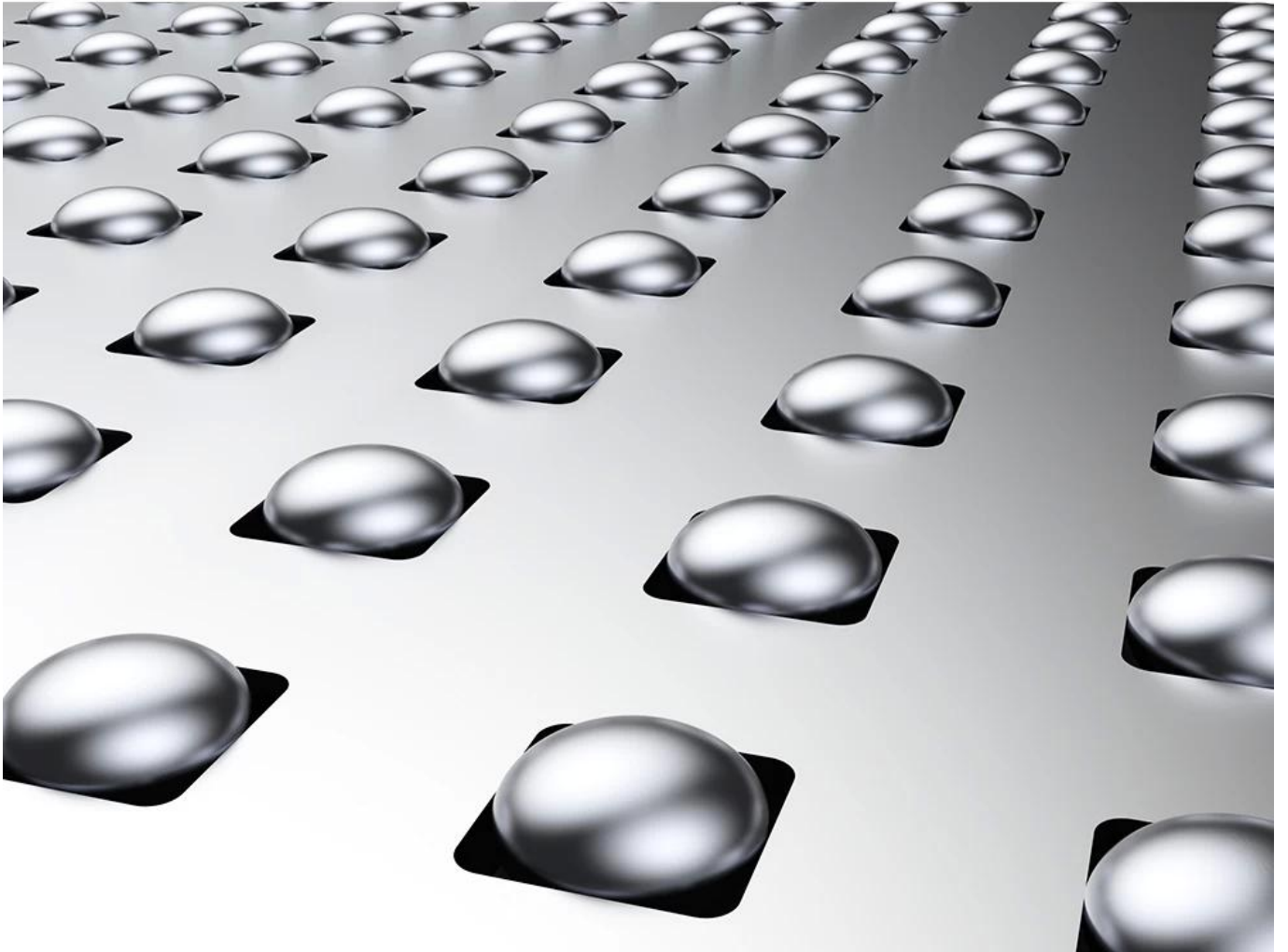
尊贵版

Made in BEST TOOL

Easily mounted on the steel mesh to make the chip fit more closely with the mesh Therefore.



Precision Reballing Stencil
Tin point is neat and tidy



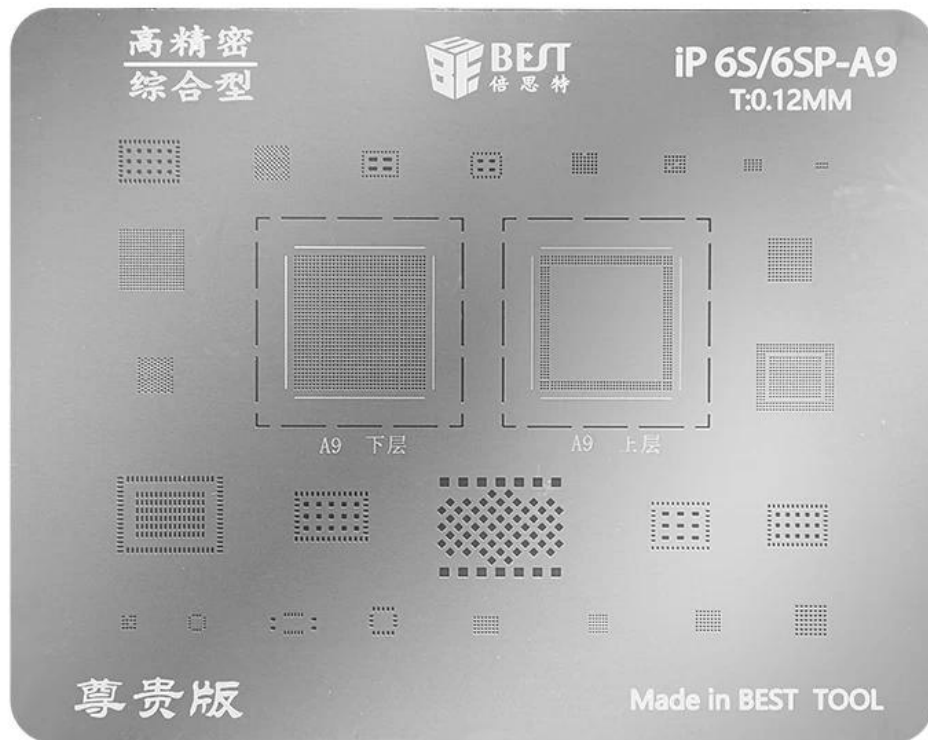


Product List

N.W.:6.9g

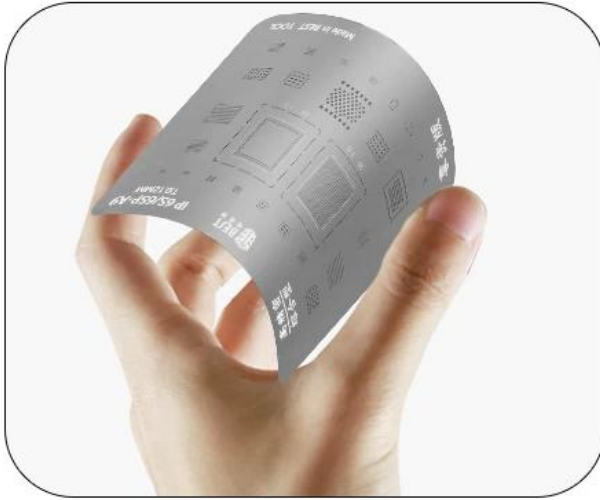
3.89 in. (98mm)

3.10 in. (79mm)



Thin to 0.12mm

Precise die-casting **form heating**



Not easily deformed and scratched

